



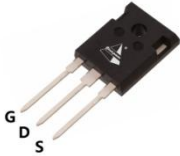
N-channel Power MOSFET

PRODUCT SUMMARY

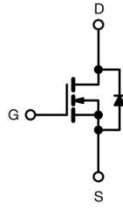
V_{DS} (V) at T_J max.	700	
$R_{DS(on)}$ max. at 25°C (Ω)	$V_{GS}=10V$	0.28
Q_g max. (nC)	160	
Q_{gs} (nC)	31	
Q_{gd} (nC)	52	
Configuration	single	

Features

- $I_D=22A(V_{GS}=10V)$
- Ultra Low Gate Charge
- Improved dv/dt Capability
- 100% Avalanche Tested
- $R_{\theta HS}$ compliant



TO-247



Schematic diagram

Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- DC to DC Converters
- LED Lighting
- Bridge Circuits

ORDERING INFORMATION

Device	SPA22N65G
Device Package	TO-247
Marking	22N65G

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ C$, unless otherwise noted)

Parameter	Symbol	Limit	Unit
		SPA22N65G	
Drain to Source Voltage	V_{DSS}	650	V
Continuous Drain Current (@ $T_C=25^\circ C$)	I_D	22 ⁽¹⁾	A
Continuous Drain Current (@ $T_C=100^\circ C$)		14 ⁽¹⁾	A
Drain current pulsed ⁽²⁾	I_{DM}	88 ⁽¹⁾	A
Gate to Source Voltage	V_{GS}	± 30	V
Single pulsed Avalanche Energy ⁽³⁾	E_{AS}	1452	mJ
Peak diode Recovery dv/dt ⁽⁴⁾	dv/dt	6	V/ns
Total power dissipation (@ $T_C=25^\circ C$)	P_D	280	W
Derating Factor above 25°C		2.2	W/°C
Operating Junction Temperature & Storage Temperature	T_{STG}, T_J	-55 to + 150	°C
Maximum lead temperature for soldering purpose	T_L	260	°C

Notes

1. Drain current is limited by maximum junction temperature.
2. Repetitive rating : pulse width limited by junction temperature.
3. $L = 6mH, I_{AS} = 22A, V_{DD} = 50V, R_G=25\Omega$, Starting at $T_J = 25^\circ C$
4. $I_{SD} \leq I_D, di/dt = 100A/us, V_{DD} \leq BV_{DSS}$, Starting at $T_J = 25^\circ C$



THERMAL CHARACTERISTICS			
Parameter	Symbol	Value	Unit
Thermal resistance, Junction to case	R_{thjc}	0.44	°C/W
Thermal resistance, Junction to ambient	R_{thja}	38	°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise specified)						
Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain to source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	650	--	--	V
Breakdown voltage temperature coefficient	$\Delta BV_{DSS} / \Delta T_J$	$I_D=250\mu A$, referenced to 25°C	--	0.49	--	V/°C
Drain to source leakage current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V$	--	--	1	μA
		$V_{DS}=520V, T_C=125^\circ\text{C}$	--	--	50	μA
Gate to source leakage current, forward	I_{GSS}	$V_{GS}=30V, V_{DS}=0V$	--	--	100	nA
Gate to source leakage current, reverse		$V_{GS}=-30V, V_{DS}=0V$	--	--	-100	nA
On Characteristics						
Gate threshold voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	--	4	V
Drain to source on state resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=11A$	--	0.24	0.28	Ω
Forward Transconductance	G_{fs}	$V_{DS}=30V, I_D=11A$	--	22	--	S
Dynamic Characteristics						
Input capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=25V, f=1\text{MHz}$	--	5220	--	pF
Output capacitance	C_{oss}		--	463	--	
Reverse transfer capacitance	C_{rss}		--	16	--	
Turn on delay time	$t_{d(on)}$	$V_{DS}=380V, I_D=22A, R_G=25\Omega$	--	73	--	ns
Rising time	t_r		--	88	--	
Turn off delay time	$t_{d(off)}$		--	206	--	
Fall time	t_f		--	78	--	
Total gate charge	Q_g	$V_{DS}=520V, V_{GS}=10V, I_D=22A$	--	120	160	nC
Gate-source charge	Q_{gs}		--	31	--	
Gate-drain charge	Q_{gd}		--	52	--	

SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS						
Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous source current	I_S	Integral reverse p-n Junction diode in the MOSFET	--	--	22	A
Pulsed source current	I_{SM}		--	--	88	A
Diode forward voltage drop.	V_{SD}	$I_S=22A, V_{GS}=0V$	--	--	1.3	V
Reverse recovery time	T_{rr}	$I_S=22A, V_{GS}=0V, di_f/dt=100A/\mu s$	--	520	--	ns
Reverse recovery Charge	Q_{rr}		--	10	--	μC



Fig1. Output characteristics

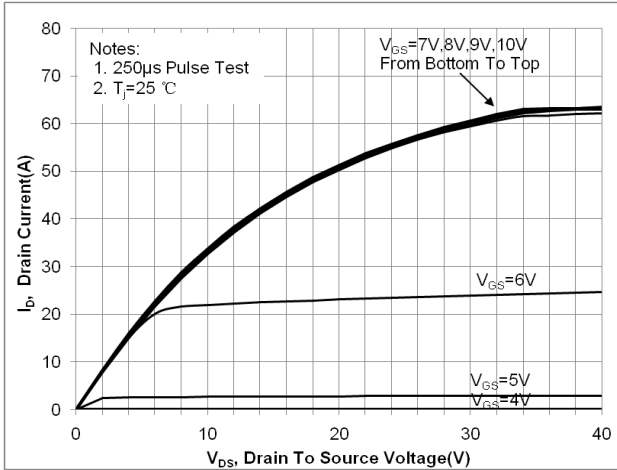


Fig2. Drain-source on-state resistance

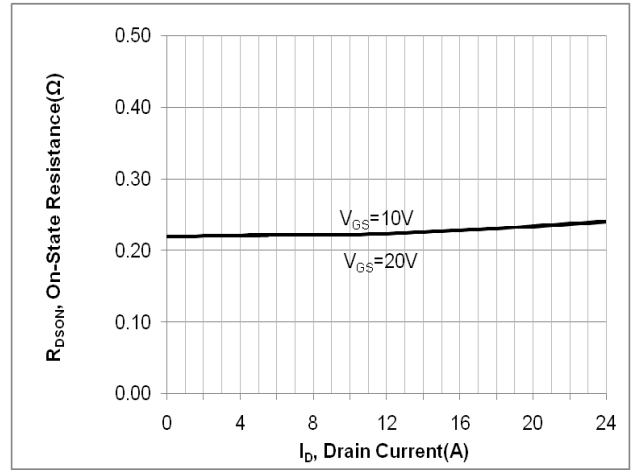


Fig3. Gate charge characteristics

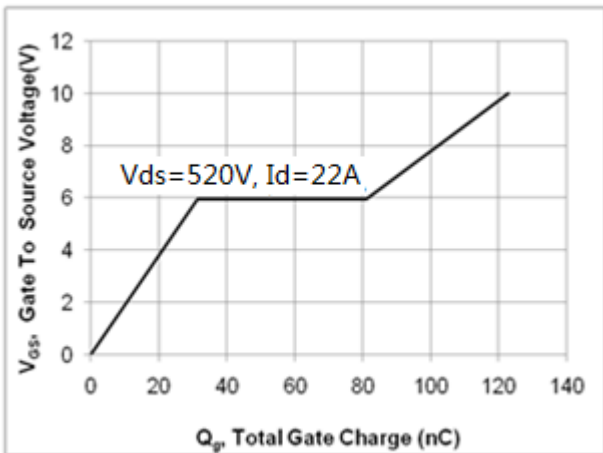


Fig 4. Capacitance Characteristics

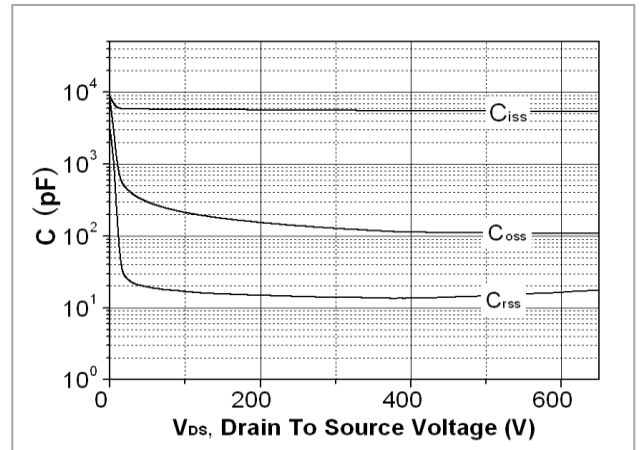


Fig 5. $R_{DS(ON)}$ vs junction temperature

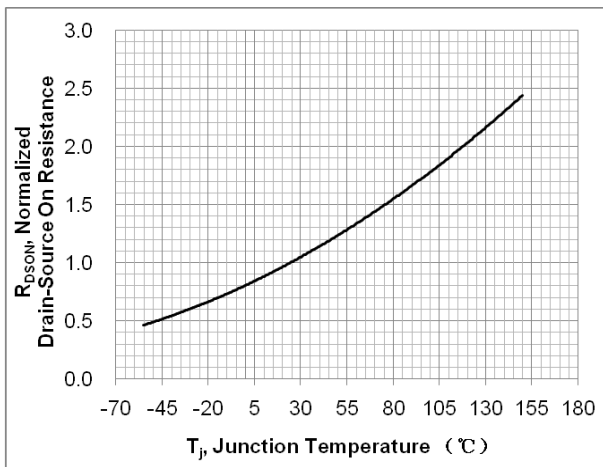


Fig 6. BV_{DSS} vs junction temperature

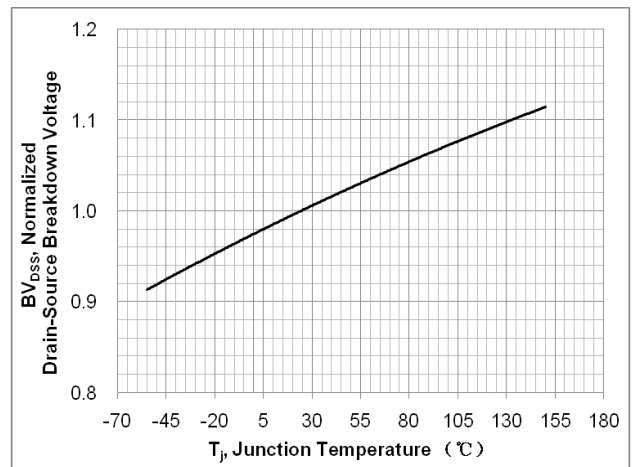


Fig 7 . Safe operating area

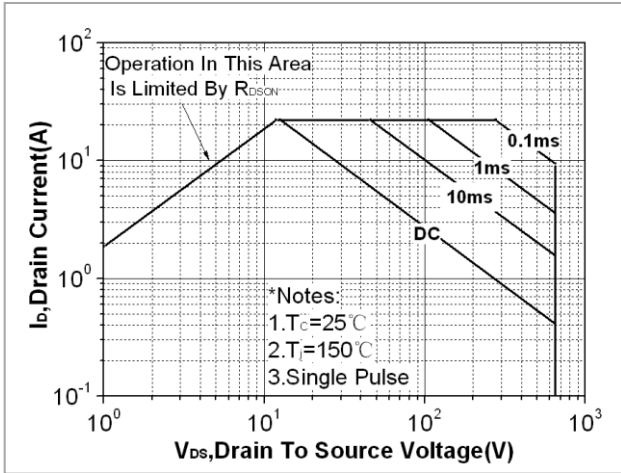


Fig 8 . Transient thermal impedance

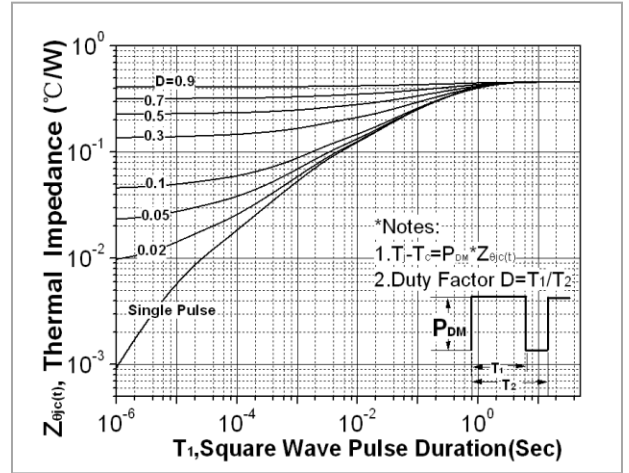


Fig 9. Forward characteristics of reverse diode

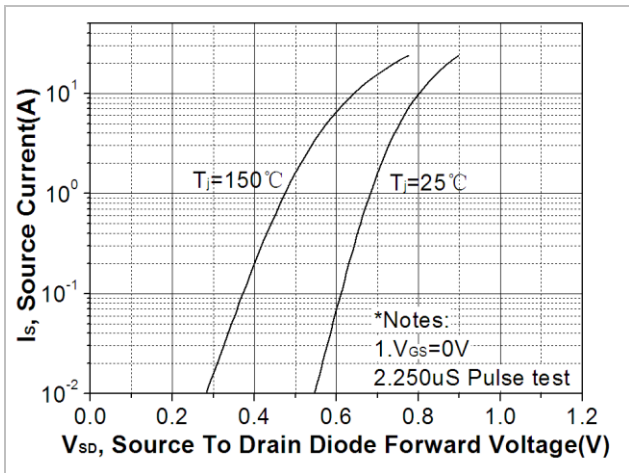


Fig 10. Gate charge test circuit & waveform

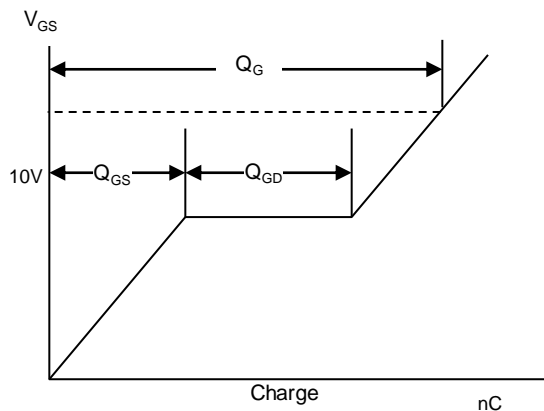
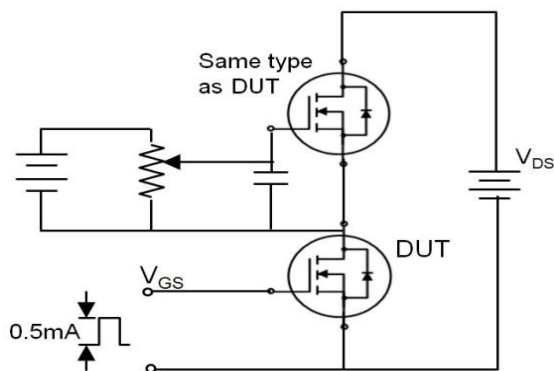


Fig 11. Switching time test circuit & waveform

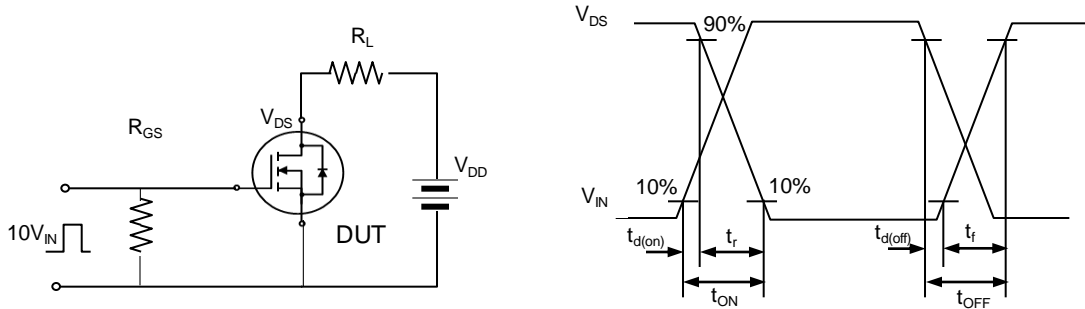


Fig 12. Unclamped Inductive switching test circuit & waveform

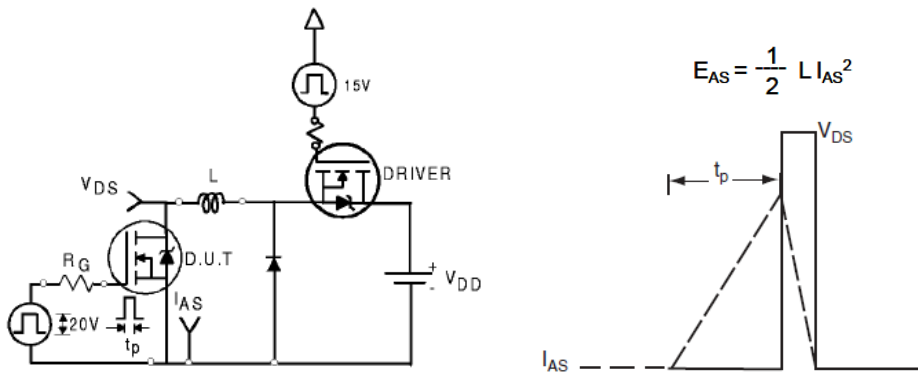
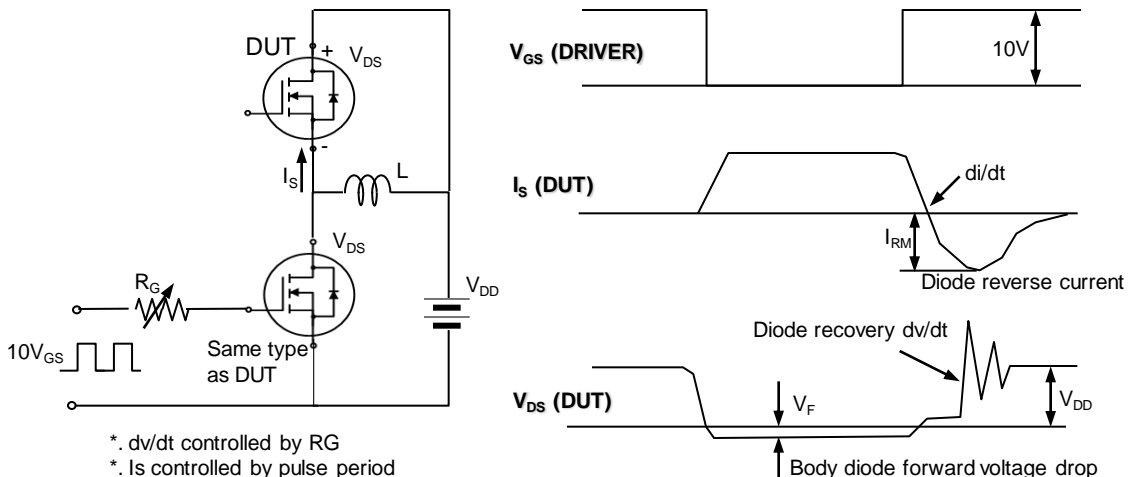


Fig 13. Peak diode recovery dv/dt test circuit & waveform





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